

真空热压烧结多功能一体炉

Multifunctional Furnace for Vacuum Hot Press Sintering

Technical Features

产品特点

- 最高加热温度:2300°C
Maximum Heating Temperature: 2300°C
- 集热压和真空烧结于一体
Integrated hot press sintering and vacuum sintering in one furnace.
- 卧式前开门设计,方便装模和卸模
Horizontal design with front-open chamber ensures easy loading and removal of mold.
- 真空度(10⁻³Pa范围),惰性气体(Ar, He, N₂)保护操作
Vacuum degree (10⁻³ Pa range) and Inert gas (Ar, He, N₂) operation.
- PLC和HMI触摸屏全自动操作
Fully automatic operation by PLC and touchscreen HMI.
- 温度和压力同时进行控制
Simultaneous temperature and pressure control.
- 基于热电偶和红外测温仪的温度控制系统
Temperature control system based on thermocouple and infrared thermometer.
- 超压、超温安全报警系统
Safety alarm system for over-pressure and over-temperature.



Application

应用

- 氮化硅陶瓷, Al₂O₃混合陶瓷, 用于切削工具TiC/TiN碳化钛/氮化钛和赛隆陶瓷, 用于高应力阀门的部件、轴承, 用于工艺技术的磨损件等;
Silicon nitride, mixed ceramics of Al₂O₃, TiC/TiN and sialon for cutting tools, components of heavy-duty valves, bearings, wear parts for process technology.
- PLZT (铅-镧-锆-钛) 和其他高度成熟的功能陶瓷 (氧气气氛)
PLZT (lead-lanthan-zircon-titanate) and other high developed functional ceramic (O₂ atmosphere).
- 用于耐磨部件和保护层的碳化硼陶瓷 (B₄C)
Boron carbide (B₄C) for extremely wear resistant parts and armors..
- 用于切削工具的SiC晶须增强的 Al₂O₃陶瓷
SiC whisker reinforced Al₂O₃ for cutting tools.
- 金属基和陶瓷基复合材料, 复合材料
MMC and CMC materials, composite materials.
- 溅射靶材和扩散焊
Sputter target & diffusion welding.

技术规格 / Main Specification

参数Spec.	型号Model	VHPgr-20/20/30-1600(P2-16)	VHPgr-20/20/30-2000(P2-20)	VHPgr-20/20/30-2300(P2-23)
设备装料方式 Equipment Loading Method		侧开门装料 Horizontal side loading		
设备外形尺寸 Equipment External Dimensions		1500×2000×1700mm(宽×高×长)/(W×H×L)		
加热元件 Heating Element		石墨板 Graphite Plate		
最高温度 Max. Temperature		1600°C	2000°C	2300°C
工作温度 Working Temperature		1500°C	1900°C	2200°C
最大功率 Max. Power		30KW	45KW	60KW
极限真空度 Max. Vacuum		6.7×10 ⁻³ Pa(空炉、冷态、经净化) 6.7×10 ⁻³ Pa (empty furnace, cold state, purified)		
控温精度 Temperature Accuracy		±1°C		
温度均匀性 Temperature uniformity		±5°C		
测温传感器 Thermocouple		B型热电偶 B-Type	钨铼热电偶 W-Re5/26(C)	钨铼热电偶+红外测温仪 W-Re5/26(C) + Infrared Thermometer
压升率 Pressure Rise Rate		≤2.0Pa/h(空炉、冷态) ≤2.0Pa/h (Empty furnace, cold state)		
气氛 Gases		氮气, 氩气 Nitrogen, Argon		
冷却水要求 Cooling Water Requirement		水压:0.2~0.3MPa, 水流量:5m ³ /小时 Water pressure: 0.2~0.3MPa, water flow: 5m ³ /h	水压:0.2~0.3MPa, 水流量:6m ³ /小时 Water pressure: 0.2~0.3MPa, water flow: 6m ³ /h	水压:0.2~0.3MPa, 水流量:8m ³ /小时 Water pressure: 0.2~0.3MPa, water flow: 8m ³ /h
电力要求 Power Requirement		三相/380V;总功率 50Kw (含真空炉用电, 真空机组用电, 冷却水用电等) Three-phase / 380 V; Total power: 50Kw (including vacuum furnace power, vacuum generator power, cooling water power, etc.)	三相/380V;总功率 60Kw (含真空炉用电, 真空机组用电, 冷却水用电等) Three-phase / 380 V; Total power: 60Kw (including vacuum furnace power, vacuum generator power, cooling water power, etc.)	三相/380V;总功率 72Kw (含真空炉用电, 真空机组用电, 冷却水用电等) Three-phase / 380 V; Total power: 72Kw (including vacuum furnace power, vacuum generator power, cooling water power, etc.)
热压烧结技术参数(即真空热压使用) / Technical parameters of hot pressing sintering (the use of vacuum hot pressing)				
最大设计压力 Max. Pressure		196KN (20Ton)		
最大模具外径 Maximum Outside Diameter of Mold		φ160×160mm(模具外径×模具总高)/(D×H)		
最大产品直径 Sample Diameter		≤φ80mm		
金属压头直径 Diameter of metal head		φ85mm		
压头行程 Max. Displacement		100mm		
加压方式 Pressing Direction		单向加压, 下加压(从下往上加压) Single way pressurization (bottom)		
真空烧结技术参数(即真空烧结使用) / Technical parameters of vacuum sintering (the use of vacuum sintering)				
最大热区空间 Maximum Heat Area Size		200×200×300mm(宽×高×长)/(W×H×L)		
有效热区空间 Effective Zone		160×160×160mm(宽×高×长)/(W×H×L)		
承烧版尺寸 Burnt Plate Size		160×160mm(宽×长)/(W×L)		

